

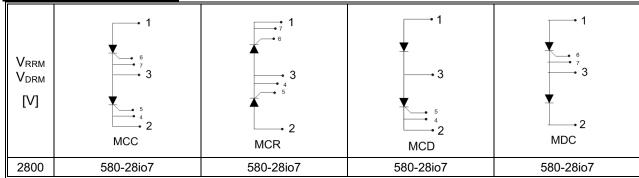


Date: 13<sup>th</sup> Mar 2013

**Data Sheet Issue: 1** 

# **Thyristor/Diode Modules MC#580**

**Absolute Maximum Ratings** 



	VOLTAGE RATINGS	MAXIMUM LIMITS	UNITS
$V_{DRM}$	Repetitive peak off-state voltage 1)	2800	V
$V_{DSM}$	Non-repetitive peak off-state voltage 1)	2900	V
$V_{RRM}$	Repetitive peak reverse voltage 1)	2800	V
$V_{RSM}$	Non-repetitive peak reverse voltage 1)	2900	V

	OTHER RATINGS	MAXIMUM LIMITS	UNITS
I <sub>T(AV)M</sub>	Maximum average on-state current, T <sub>C</sub> = 85°C <sup>2)</sup>	581	Α
$I_{T(AV)M}$	Maximum average on-state current. T <sub>C</sub> = 100°C <sup>2)</sup>	403	Α
$I_{T(RMS)M}$	Nominal RMS on-state current, T <sub>C</sub> = 55°C <sup>2)</sup>	1372	Α
$I_{T(d.c.)}$	D.C. on-state current, T <sub>C</sub> = 55°C	1102	Α
I <sub>TSM</sub>	Peak non-repetitive surge $t_p$ = 10 ms, $V_{RM}$ = 60% $V_{RRM}$ <sup>3)</sup>	18.9	kA
I <sub>TSM2</sub>	Peak non-repetitive surge $t_p$ = 10 ms, $V_{RM} \le 10V^{3}$	21.0	kA
l <sup>2</sup> t	$I^2$ t capacity for fusing $t_p = 10$ ms, $V_{RM} = 60\% V_{RRM}^{3}$	1790	kA <sup>2</sup> s
l <sup>2</sup> t	$I^2$ t capacity for fusing $t_p$ = 10 ms, $V_{RM} \le 10 \text{ V}^{-3}$	2205	kA <sup>2</sup> s
( 4: / 44 )	Critical rate of rise of on-state current (repetitive) 4)	200	A/µs
(di/dt) <sub>cr</sub>	Critical rate of rise of on-state current (non-repetitive) 4)	400	A/µs
$V_{RGM}$	Peak reverse gate voltage	5	V
$P_{G(AV)}$	Mean forward gate power	4	W
$P_GM$	Peak forward gate power	40	W
V <sub>ISOL</sub>	Isolation Voltage <sup>5)</sup>	3000	V
T <sub>vj op</sub>	Operating temperature range	-40 - +125	°C
T <sub>stg</sub>	Storage temperature range	-40 - +125	°C

#### Notes

- 1) De-rating factor of 0.13% per °C is applicable for T<sub>vj</sub> below 25°C.
- 2) Single phase; 50 Hz, 180° half-sinewave.
- 3) Half-sinewave, 125°C T<sub>vj</sub> initial.
- 4)  $V_D = 67\% \ V_{DRM}$ ,  $I_{FG} = 2 \ A$ ,  $t_r \le 0.5 \mu s$ ,  $T_C = 125 ^{\circ} C$ .
- 5) AC RMS voltage, 50 Hz, 1min test



### **Characteristics**

	PARAMETER	MIN.	TYP.	MAX.	TEST CONDITIONS 1)	UNITS
V <sub>TM</sub>	Maximum peak on-state voltage	-	-	1.123	$I_{TM} = 630A$ , $T_{vj} = T_{vjMAX}$	V
$V_{TM}$	Maximum peak on-state voltage	-	-	1.517	$I_{TM} = 1890A$ , $T_{vj} = T_{vjMAX}$	V
$V_{T0}$	Threshold voltage	-	-	0.926		V
r <sub>T</sub>	Slope resistance	-	-	0.313		mΩ
(dv/dt) <sub>c</sub>	Critical rate of rise of off-state voltage	1000	-	-	V <sub>D</sub> = 0.67% V <sub>DRM</sub> , Gate o/c	V/μs
I <sub>DRM</sub>	Peak off-state current	-	-	200	Rated V <sub>DRM</sub>	mA
I <sub>RRM</sub>	Peak reverse current	-	-	200	Rated V <sub>RRM</sub>	mA
$V_{GT}$	Gate trigger voltage	-	-	2.5	T - 25°C V - 12 V I - 2 A	٧
I <sub>GT</sub>	Gate trigger current	-	-	250	$T_{vj} = 25^{\circ}C, V_D = 12 \text{ V}, I_T = 3 \text{ A}$	mA
$V_{GD}$	Gate non-trigger voltage	0.25	-	-	67% V <sub>DRM</sub>	٧
I <sub>H</sub>	Holding current	-	-	300	V <sub>D</sub> = 12 V, T <sub>vj</sub> = 25°C	mA
t <sub>gd</sub>	Gate controlled turn-on delay time	-	2.50	-	$I_{FG} = 2 \text{ A}, t_r = 0.5 \text{ µs}, V_D = 40\% V_{DRM},$	μs
t <sub>gt</sub>	Turn-on time	-	3.50	-	$I_{TM} = 800A$ , di/dt = 10 A/ $\mu$ s, $T_{vj} = 25$ °C	μs
Qrr	Recovered Charge	-	-	3500		μC
Q <sub>ra</sub>	Recovered Charge, 50% chord	-	-	3050	  I <sub>TM</sub> = 630A, di/dt = 10A/μs,	μC
I <sub>rm</sub>	Reverse recovery current	-	-	190	V <sub>R</sub> = 100 V	Α
t <sub>rr</sub>	Reverse recovery time, 50% chord	-	-	37		μs
t <sub>q</sub>	Turn-off time	-	-	320	$I_{TM}$ = 630A, di/dt = 10 A/µs, V <sub>R</sub> = 100 V, V <sub>DR</sub> = 67%V <sub>DRM</sub> , dv <sub>DR</sub> /dt = 50 V/µs	μs
_	The second resistance is resting to seco	-	-	0.050	Single Thyristor	K/W
$R_{thJC}$	Thermal resistance, junction to case	-	-	0.025	Whole Module	K/W
_	The same of the sa	-	-	0.016	Single Thyristor	K/W
R <sub>thCH</sub>	Thermal resistance, case to heatsink	-	-	0.008	Whole Module	K/W
F <sub>1</sub>	Mounting force (to heatsink)		-	9.00		Nm
F <sub>2</sub>	Mounting force (to terminals)		-	18.00	2)	Nm
Wt	Weight	-	3.5	-		kg

#### Notes:

- Unless otherwise indicated T<sub>vj</sub>=125°C.
   Screws must be lubricated.



#### **Notes on Ratings and Characteristics**

#### 1.0 Voltage Grade Table

Voltage Grade	V <sub>DRM</sub> V <sub>RRM</sub>	V <sub>DSM</sub> V <sub>RSM</sub>	V <sub>D</sub> V <sub>R</sub>	
	V	V	DC V	
28	2800	2900		

#### 2.0 Extension of Voltage Grades

This report is applicable to other voltage grades when supply has been agreed by Sales/Production.

#### 3.0 De-rating Factor

A blocking voltage de-rating factor of 0.13%/°C is applicable to this device for T<sub>vi</sub> below 25°C.

#### 4.0 Repetitive dv/dt

Standard dv/dt is 1000V/µs.

#### 5.0 Snubber Components

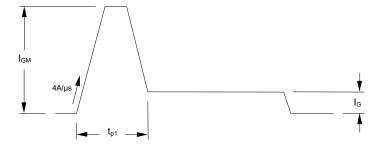
When selecting snubber components, care must be taken not to use excessively large values of snubber capacitor or excessively small values of snubber resistor. Such excessive component values may lead to device damage due to the large resultant values of snubber discharge current. If required, please consult the factory for assistance.

#### 6.0 Rate of rise of on-state current

The maximum un-primed rate of rise of on-state current must not exceed 400A/µs at any time during turn-on on a non-repetitive basis. For repetitive performance, the on-state rate of rise of current must not exceed 200A/µs at any time during turn-on. Note that these values of rate of rise of current apply to the total device current including that from any local snubber network.

#### 7.0 Gate Drive

The nominal requirement for a typical gate drive is illustrated below. An open circuit voltage of at least 30V is assumed. This gate drive must be applied when using the full di/dt capability of the device.



The magnitude of  $I_{GM}$  should be between five and ten times  $I_{GT}$ , which is shown on page 2. Its duration  $(t_{p1})$  should be 20µs or sufficient to allow the anode current to reach ten times  $I_L$ , whichever is greater. Otherwise, an increase in pulse current could be needed to supply the necessary charge to trigger. The 'back-porch' current  $I_G$  should remain flowing for the same duration as the anode current and have a magnitude in the order of 1.5 times  $I_{GT}$ .



#### 8.0 Computer Modelling Parameters

#### 8.1 Thyristor Dissipation Calculations

$$I_{AV} = \frac{-V_{T0} + \sqrt{{V_{T0}}^2 + 4 \cdot ff^2 \cdot r_T \cdot W_{AV}}}{2 \cdot ff^2 \cdot r_T} \qquad \text{and:} \qquad W_{AV} = \frac{\Delta T}{R_{th}} \\ \Delta T = T_{j \max} - T_K$$

Where  $V_{T0} = 0.926 \text{ V}$ ,  $r_T = 0.313 \text{ m}\Omega$ .

 $R_{th}$  = Supplementary thermal impedance, see table below and

ff = Form factor, see table below.

Supplementary Thermal Impedance							
Conduction Angle 30° 60° 90° 120° 180° 270° d.c.							d.c.
Square wave 0.0595 0.0561 0.0547 0.0537 0.0525 0.0511 0.050							0.0500
Sine wave 0.0536 0.0527 0.0522 0.0518 0.0500							

Form Factors							
Conduction Angle         30°         60°         90°         120°         180°         270°         d.c.						d.c.	
Square wave	3.464	2.449	2	1.732	1.414	1.149	1
Sine wave	3.98	2.778	2.22	1.879	1.57		

#### 8.2 Calculating thyristor V<sub>T</sub> using ABCD Coefficients

The on-state characteristic  $I_T$  vs.  $V_T$ , on page 6 is represented by a set of constants A, B, C, D, forming the coefficients of the representative equation for  $V_T$  in terms of  $I_T$  given below:

$$V_T = A + B \cdot \ln(I_T) + C \cdot I_T + D \cdot \sqrt{I_T}$$

The constants, derived by curve fitting software, are given below for both hot and cold characteristics. The resulting values for  $V_T$  agree with the true device characteristic over a current range, which is limited to that plotted.

	25°C Coefficients		125°C Coefficients	
Α	8.710824E-01	A 6.094066E-01		
В	2.260553E-02	B 5.782485E-02		
С	1.541302E-04	С	2.850626E-04	
D	1.321515E-03	D	-1.554700E-03	



#### 8.3 D.C. Thermal Impedance Calculation

$$r_t = \sum_{p=1}^{p=n} r_p \cdot \left(1 - e^{\frac{-t}{\tau_p}}\right)$$

Where p = 1 to n and:

n = number of terms in the series

t = Duration of heating pulse in seconds

rt = Thermal resistance at time t

r<sub>p</sub> = Amplitude of p<sub>th</sub> term

 $\tau_p$  = Time Constant of  $r_{th}$  term

The coefficients for this device are shown in the table below:

D.C.										
Term 1 2 3 4 5 6										
$r_p$	0.02506	0.009643	0.00348	0.009712	0.001719	0.0004399				
$ au_{ ho}$	8.474	1.110	0.2289	0.04529	0.009524	0.0002414				

#### 9.0 Reverse recovery ratings

(i)  $Q_{\text{ra}}$  is based on 50%  $I_{\text{RM}}$  chord as shown in Fig. 1

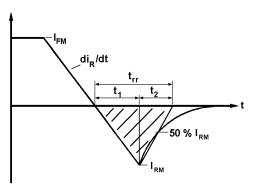


Fig. 1

(ii)  $Q_{rr}$  is based on a 150  $\mu s$  integration time i.e.

$$Q_{rr} = \int_{0}^{150 \, \mu s} i_{rr}.dt$$

(iii) 
$$K Factor = \frac{t_1}{t_2}$$



**Curves** 

### Figure 1 – On-state characteristics of Limit device

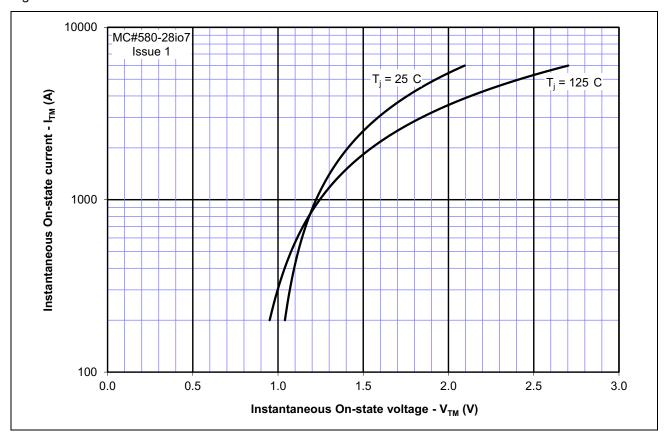


Figure 2 – Gate characteristics – Trigger limits

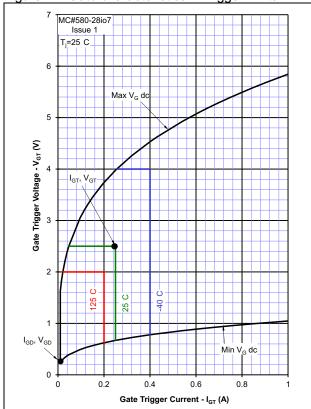


Figure 3 – Gate characteristics – Power curves

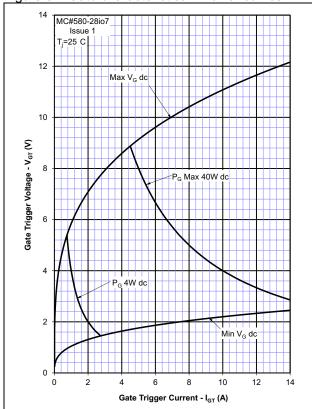




Figure 4 - Recovered charge, Q<sub>rr</sub>

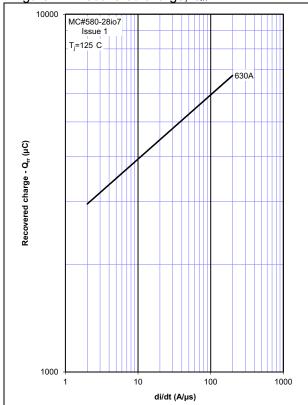
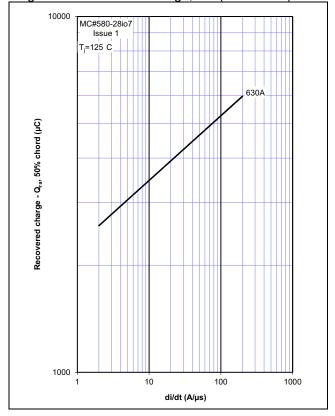


Figure 5 – Recovered charge, Q<sub>ra</sub> (50% chord)



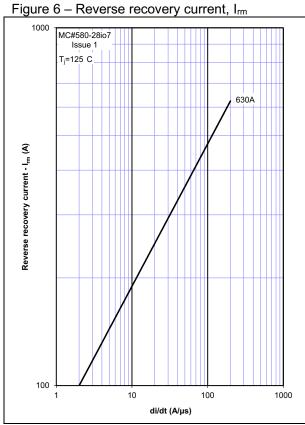


Figure 7 – Reverse recovery time,  $t_{rr}$ 

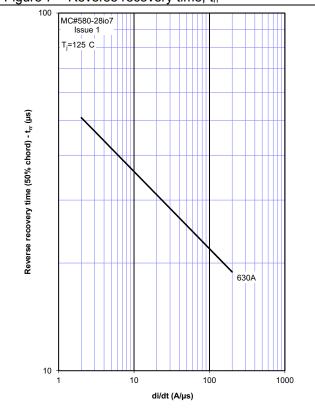




Figure 8 – On-state current vs. Power dissipation – Sine wave

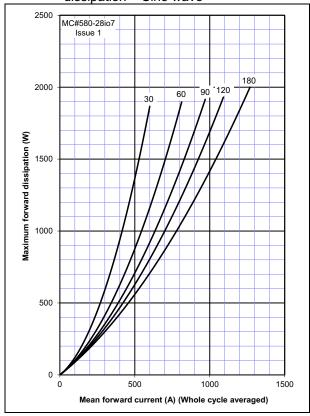


Figure 10 – On-state current vs. Power dissipation – Square wave

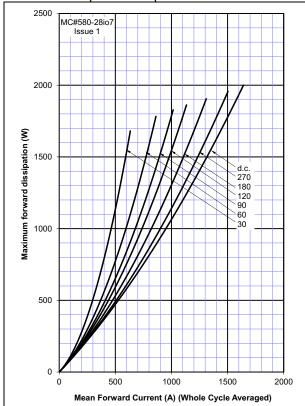


Figure 9 – On-state current vs. case temperature – Sine wave

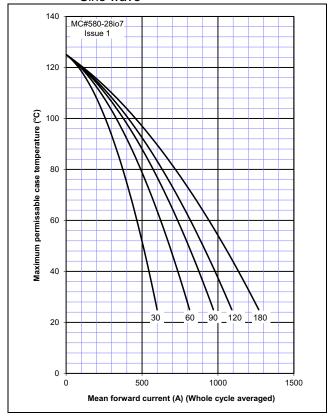


Figure 11 – On-state current vs. case temperature – Square wave

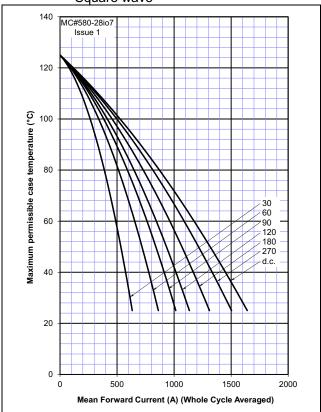




Figure 12 – Maximum surge and I<sup>2</sup>t Ratings

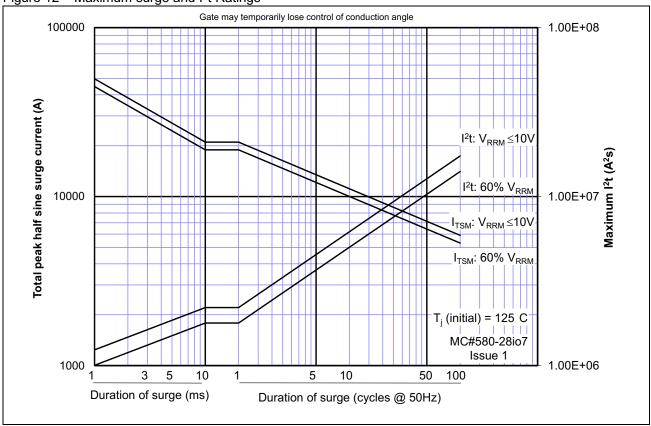
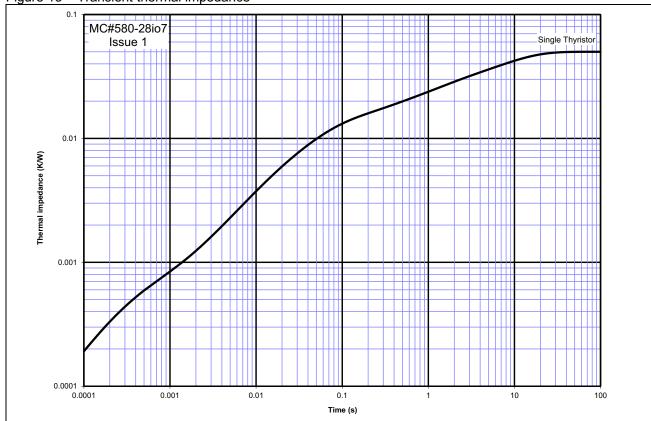
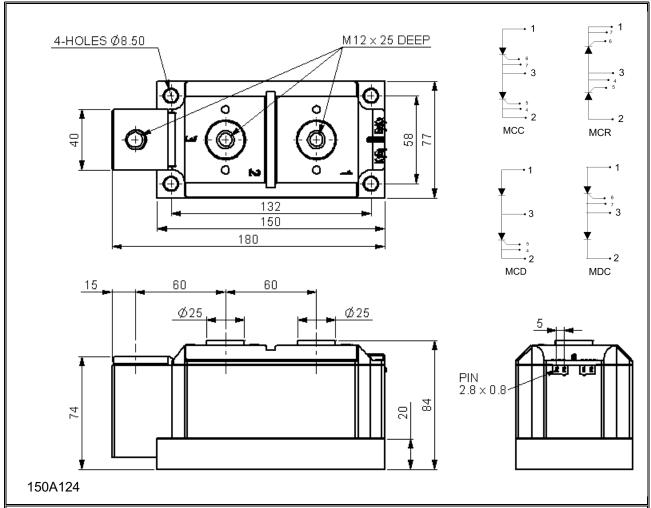


Figure 13 – Transient thermal impedance





#### **Outline Drawing & Ordering Information**



	ORDERING INFO	DRMATION	(Please qu	uote 11 digit code as below)	
М	C#	580	**	io	7
Fixed Type Code	Configuration code CC, CD or DC	Fixed Type Code	Voltage code V <sub>RRM</sub> /100 28	i = Critical dv/dt 1000 V/μs o = Typical turn-off time	Fixed Version Code

Typical order code: MCC580-28io7– MCC configuration, 2800V  $V_{\text{RRM}}$ 

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